



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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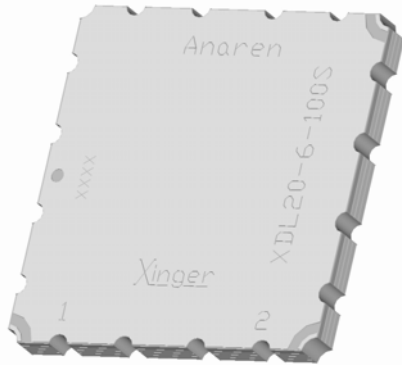
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Xinger®

Delay Line



Description

The XDL20-6-100 is a surface mount delay line that uses a slow wave coupling structure that maximizes the amount of delay per unit area over other distributed delay structures. The XDL20-6-100 can be used in amplifier linearization applications from 850 – 2000 MHz. The XDL20-6-100 is ideal for the delay element required in the main loop of feed forward amplifiers. The Xinger® delay lines are a low cost, high quality alternative to the traditional coaxial and filter solutions presently available. Parts have been subjected to rigorous qualification testing and units are 100% tested. Available 6 of 6 tin immersion (XDL20-6-100S) RoHS compliant finishes.

ELECTRICAL SPECIFICATIONS

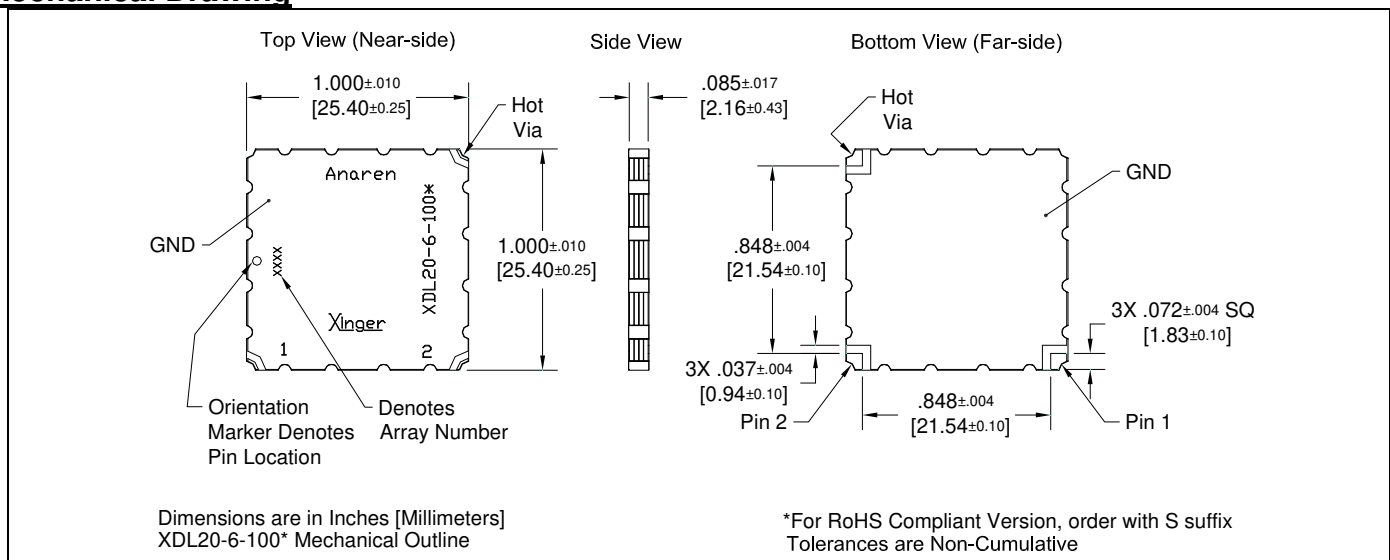
Features:

- Production Friendly
- Consistent Delay
- Stable over Temperature
- Surface Mountable
- Available in Tape&Reel
- Non-Lead Solder Paste Compatible
- Available in Lead-Free (as illustrated) or Tin-Lead
- 100% Tested

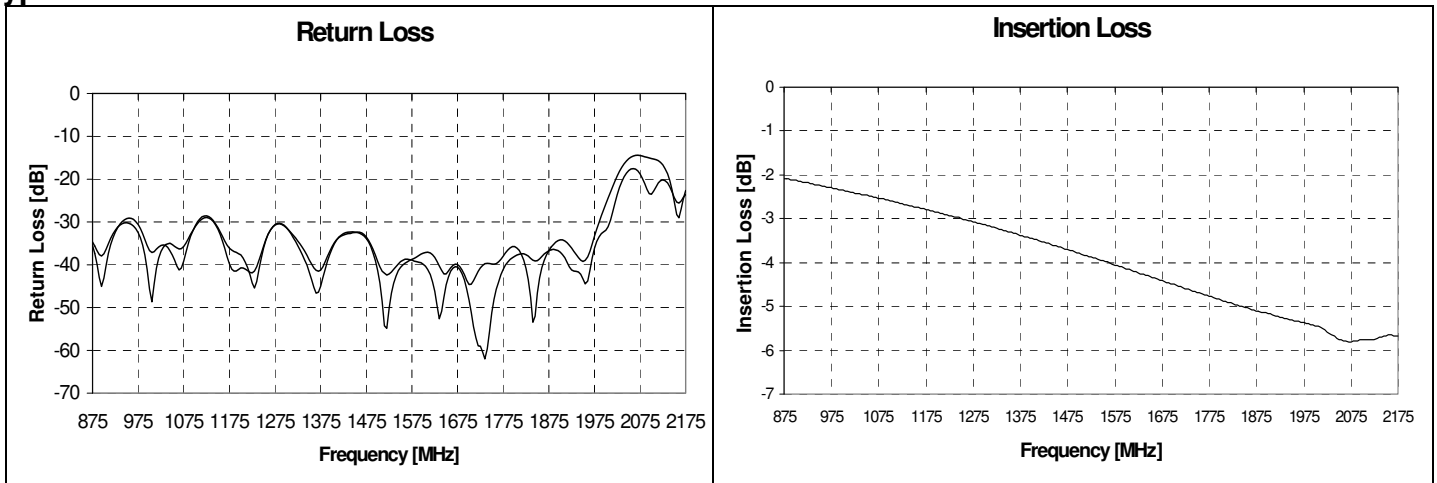
Frequency (MHz.)	869-894 AMPS Band	925-960 GSM Band	1805-1880 DCS Band	1930-1990 PCS Band
Mean Delay (nS)	5.64 ± 0.11	5.76 ± 0.11	9.42 ± 0.19	9.82 ± 0.20
Deviation from Linear Phase (Degrees Max)	± 1.00	± 1.00	± 2.00	± 2.00
Amplitude Flatness (dB p-p)	0.10	0.15	0.30	0.25
Return Loss (dB min)	20	20	20	20
Insertion Loss (dB/nS)	0.45	0.45	0.60	0.65
Power Handling (Watts)	1	1	1	1
ΘJC (°C/watts)	4.3	4.3	4.3	4.3
Operating Temp. (°C)	-55 to +85	-55 to +85	-55 to +85	-55 to +85

Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Mechanical Drawing



Typical Performance: 875 to 2175MHz



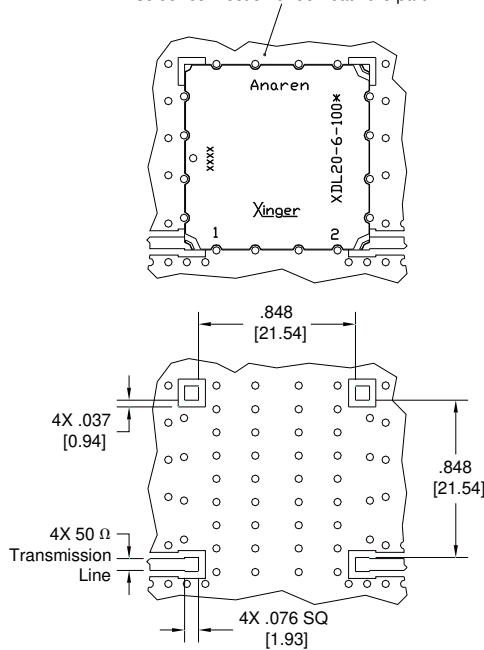
AVERAGE DELAY

The average delay is defined as the group delay of the input signal through the delay line. Because the Xinger delay lines take advantage of a narrow band tuning technique, the average delay over the broad band varies. The lot-to-lot variation is reflected in the plus/minus tolerance given in specifications.

Refer to Anaren Application Note AAN-232 for further information on Xinger delay lines.

Mounting Guidelines:

To ensure proper electrical and thermal performance there must be a ground plane with 100% solder connection underneath the part



Dimensions are in Inches [Millimeters]
XDL20-6-100* Rev A Mounting Footprint

In order for Xinger surface mount delay lines to work optimally, there must be 50Ω transmission lines leading to and from all of the RF ports. Also, there must be a very good ground plane under the part with a number of plated thru holes to ensure proper electrical performance. If any of these conditions are not satisfied, insertion loss, average delay and VSWR may not meet published specifications.

When a surface mount delay line is mounted to a printed circuit board (PCB), the primary concerns are; insuring the RF pads of the device are in contact with the circuit trace of the PCB and the ground plane of neither the component nor the PCB are in contact with the RF signal. An example of how the PCB footprint could look is shown below. In particular designs, the 50Ω lines need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.

USA/Canada: (315) 432-8909
Toll Free: (800) 544-2414
Europe: +44 2392-232392

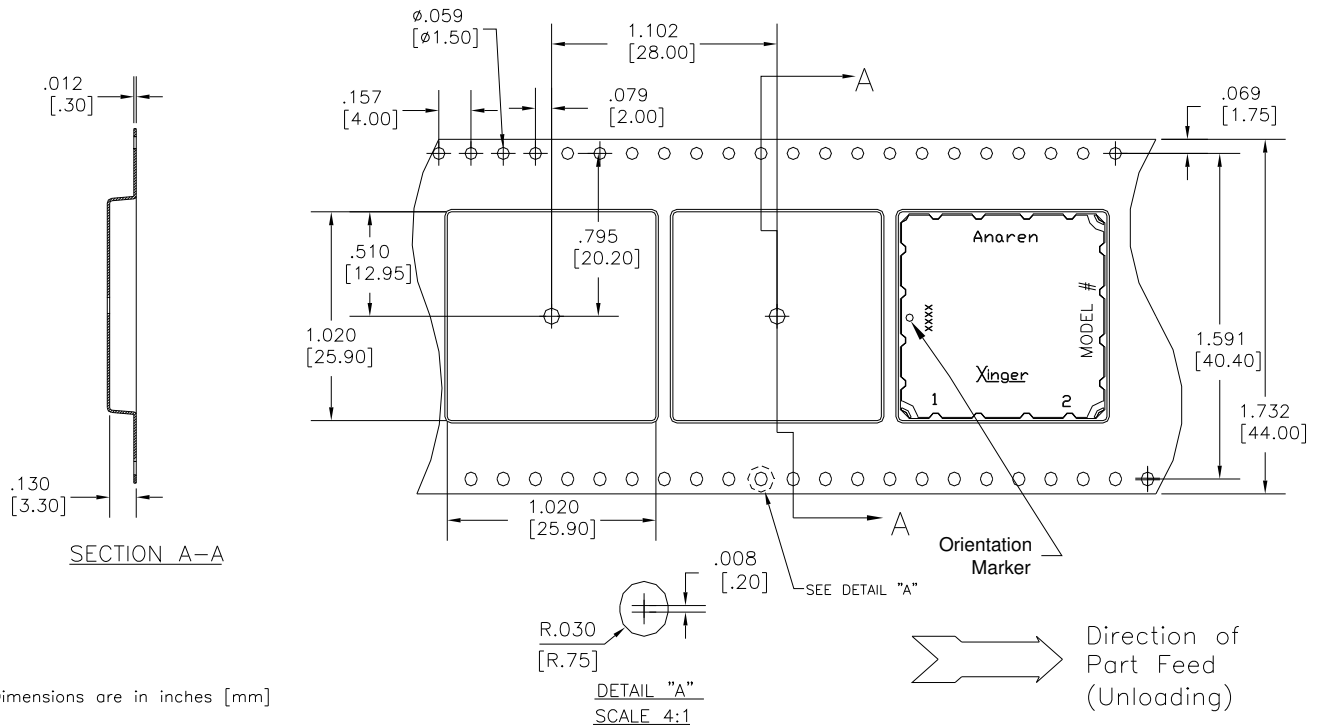
Available on Tape and Reel For Pick and Place Manufacturing.





Packaging and Ordering Information

Parts are available in both reel and tube. Packaging follows EIA 481-2. Parts are oriented in tape and reel as shown below. Minimum order quantities are 350 per reel and 23 per tube.



REEL

